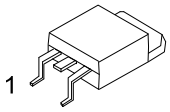
UTT28N15

POWER MOSFET

28A, 150V N-CHANNEL POWER MOSFET



TO-252

■ DESCRIPTION

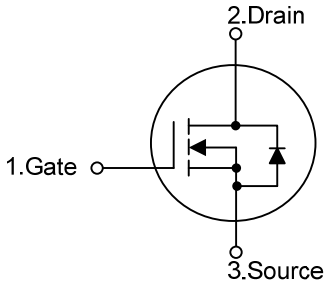
The UTC **UTT28N15** is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance, low gate charge and high switching speed.

The UTC **UTT28N15** is suitable for high voltage synchronous rectifier and DC/DC converters, etc.

■ FEATURES

* $R_{DS(ON)} \leq 54m\Omega$ @ V_{GS}=10V, I_D=14A
  $R_{DS(ON)} \leq 60m\Omega$ @ V_{GS}=4.5V, I_D=14A
* High Switching Speed
* High Cell Density Trench Technology

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UTT28N15L-TN3-R	UTT28N15G-TN3-R	TO-252	G	D	S	Tape Reel

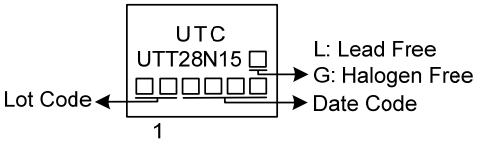
Note: Pin Assignment: G: Gate D: Drain S: Source

UTT28N15G-TN3-R

(1)Packing Type
(2)Package Type
(3)Green Package

(1) R: Tape Reel
(2) TN3: TO-252
(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATING (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	150	V
Gate-Source Voltage		V_{GSS}	±20	V
Drain Current	Continuous	I_D	28	A
	Pulsed (Note 2)	I_{DM}	56	A
Avalanche Energy (Note 3)	Single Pulsed (Note 3)	E_{AS}	296	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.6	V/nS
Power Dissipation		P_D	41.7	W
Junction Temperature		T_J	+150	°C
Storage Temperature Range		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. L=10mH, I_{AS}=7.7A, V_{DD}=50V, R_G = 25Ω, Starting T_J = 25°C
4. I_{SD} ≤28A, di/dt ≤100A/μs, V_{DD} ≤ $V_{(BR)DSS}$, T_J ≤ 25°C

■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	110	°C/W
Junction to Case	θ_{JC}	2.99 (Note)	°C/W

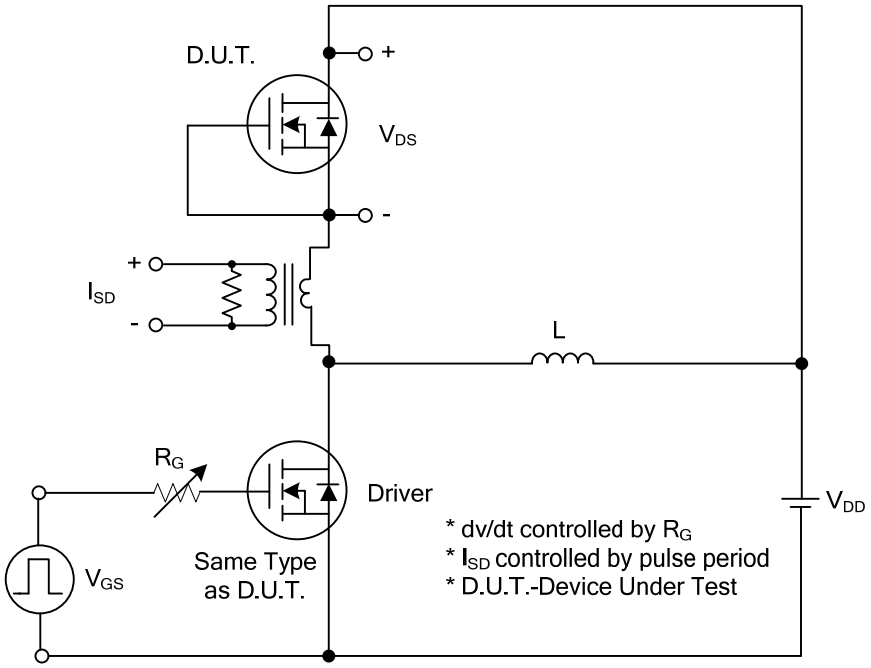
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

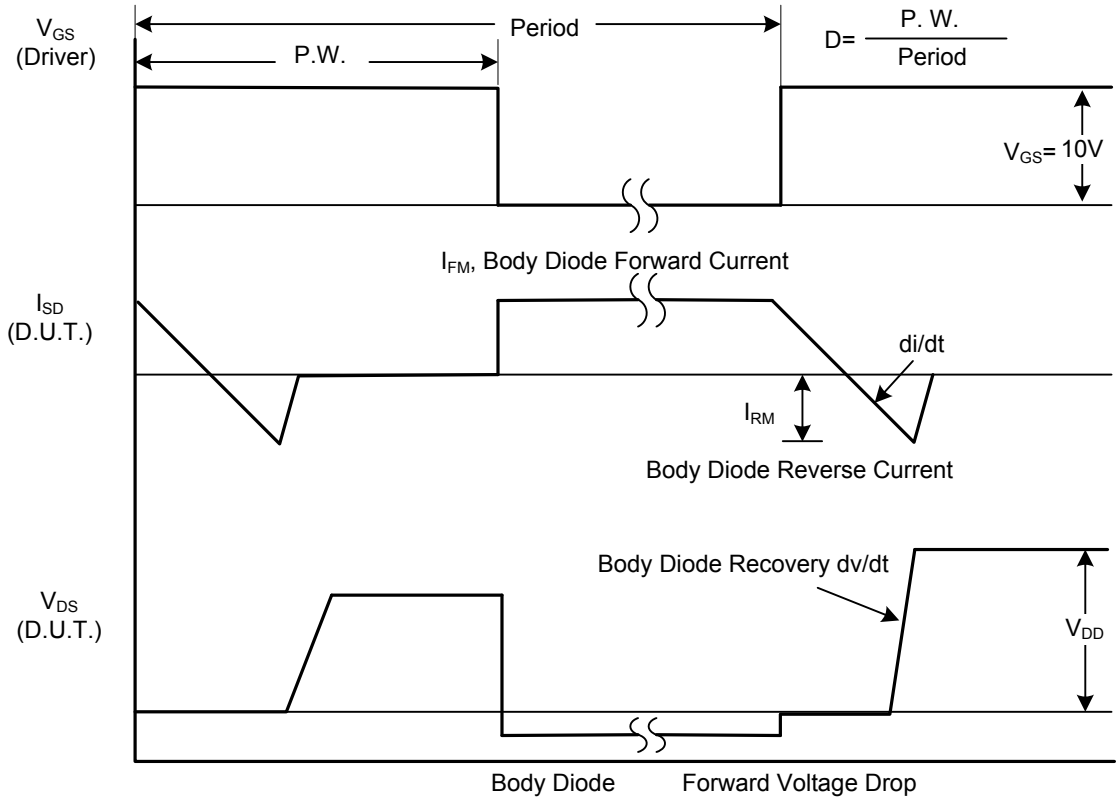
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D=250μA, V_{GS}=0V	150			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=150V, V_{GS}=0V			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS}=+20V, V_{DS}=0V			+100	nA
	Reverse		V_{GS}=-20V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	1.0		3.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=14A			54	mΩ
			V_{GS}=4.5V, I_D=14A			60	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{GS}=0V, V_{DS}=25V, f=1.0MHz		2600		pF
Output Capacitance		C_{OSS}			177		pF
Reverse Transfer Capacitance		C_{RSS}			110		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	V_{DS}=120V, V_{GS}=10V, I_D=28A I_G=1mA (Note 1, 2)		63		nC
Gate to Source Charge		Q_{GS}			6.5		nC
Gate to Drain Charge		Q_{GD}			16		nC
Turn-on Delay Time (Note 1)		$t_{D(ON)}$	V_{DS}=100V, V_{GS}=10V, I_D =28A, R_G =25Ω (Note 1, 2)		20		ns
Rise Time		t_R			36		ns
Turn-off Delay Time		$t_{D(OFF)}$			220		ns
Fall-Time		t_F			120		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				28	A
Maximum Body-Diode Pulsed Current		I_{SM}				56	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S=28A, V_{GS}=0V			1.4	V
Reverse Recovery Time (Note 1)		t_{rr}	I_S=28A, V_{GS}=0V, dI/dt=100A/μs		63		nS
Reverse Recovery Charge		Q_{rr}			118		nC

Notes: 1. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

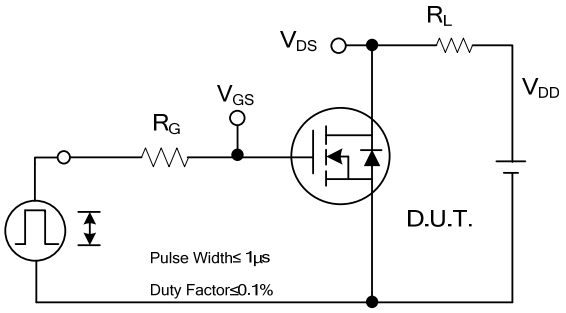


Peak Diode Recovery dv/dt Test Circuit

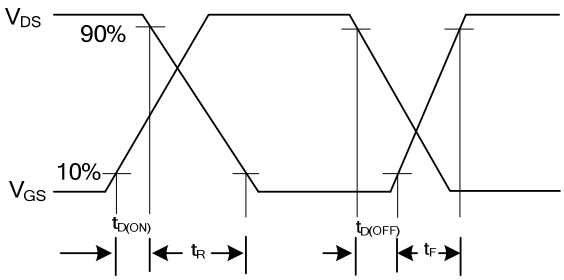


Peak Diode Recovery dv/dt Waveforms

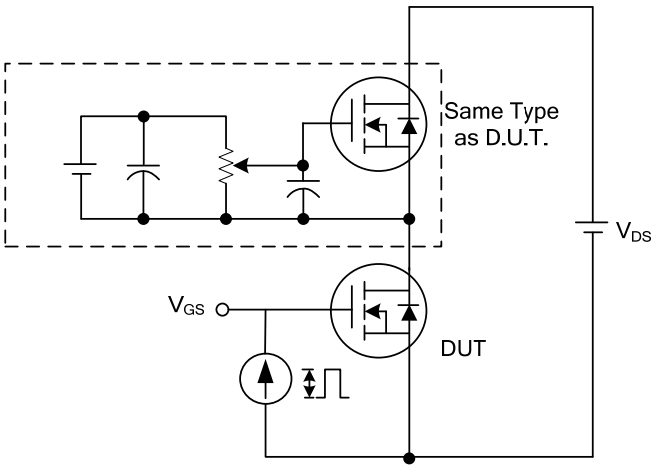
■ TEST CIRCUITS AND WAVEFORMS



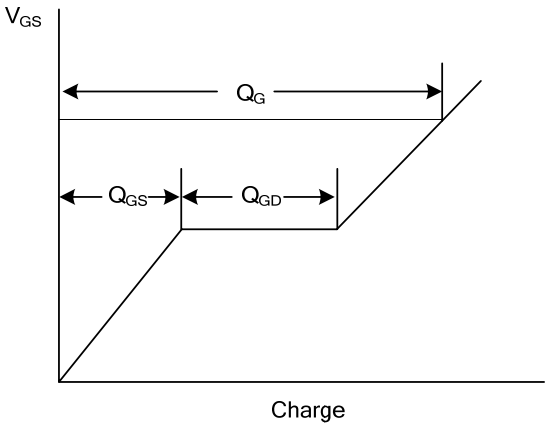
Switching Test Circuit



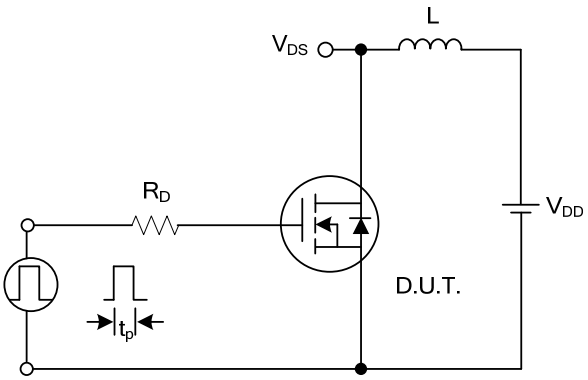
Switching Waveforms



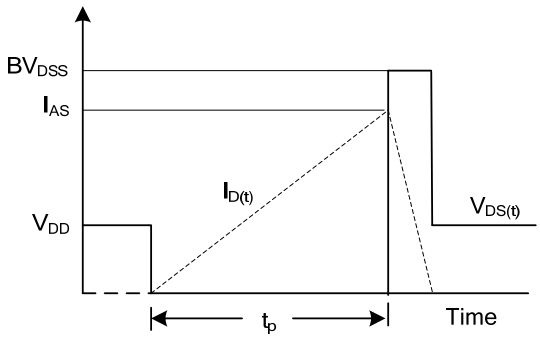
Gate Charge Test Circuit



Gate Charge Waveform



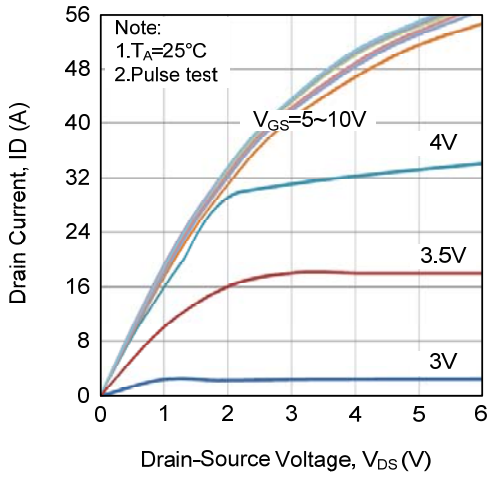
Unclamped Inductive Switching Test Circuit



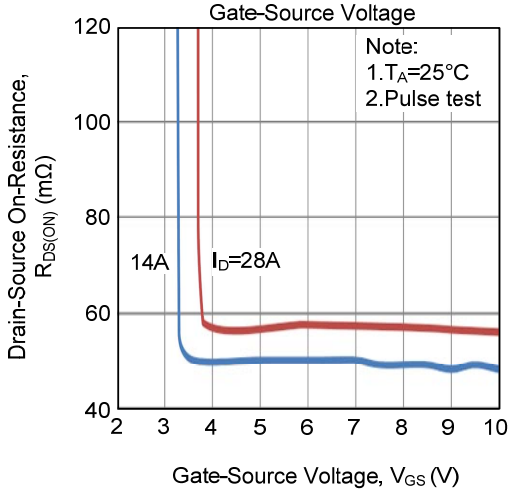
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

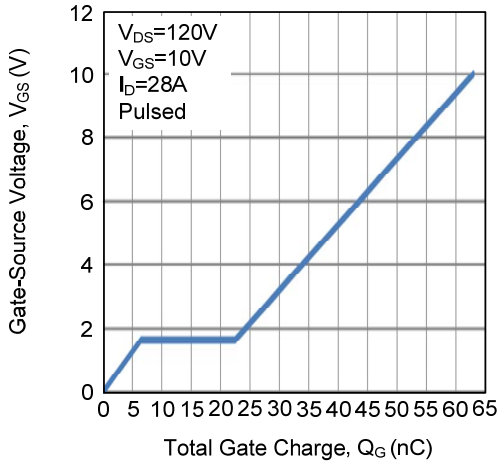
Drain Current vs. Drain-Source Voltage



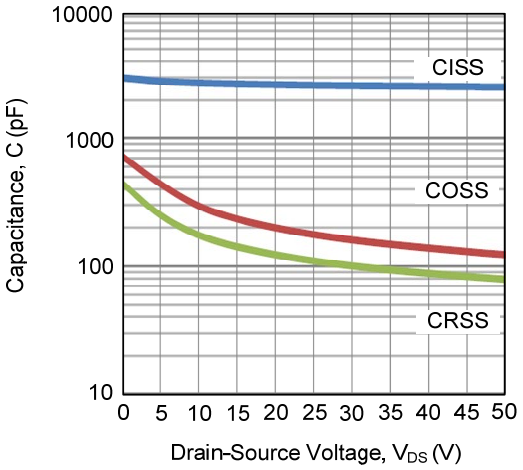
Drain-Source On-Resistance vs. Gate-Source Voltage



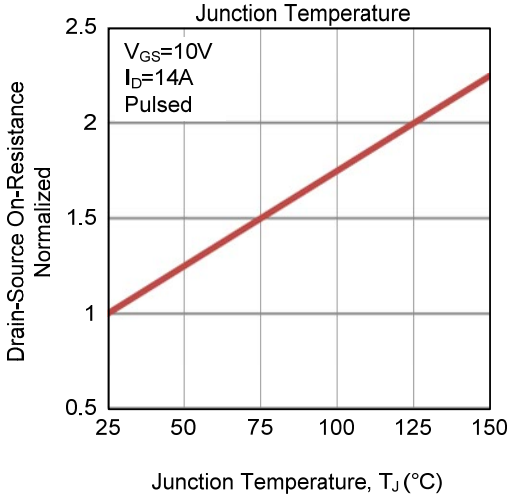
Gate Charge Characteristics



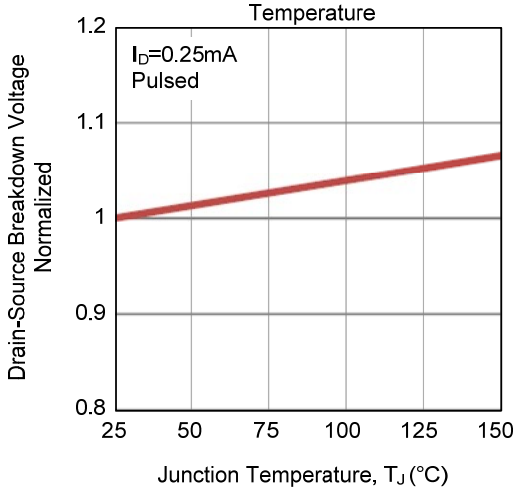
Capacitance Characteristics



Drain-Source On-Resistance vs. Junction Temperature

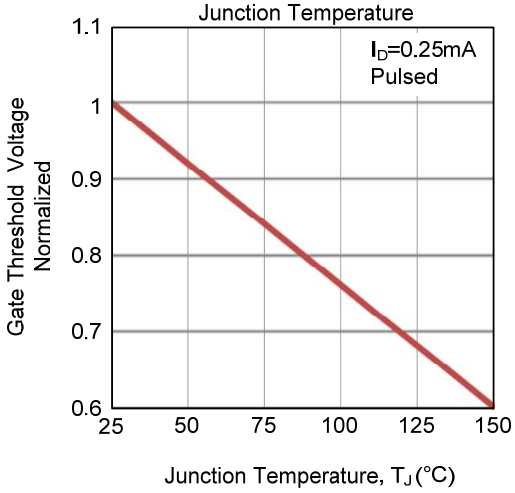


Breakdown Voltage vs. Junction Temperature

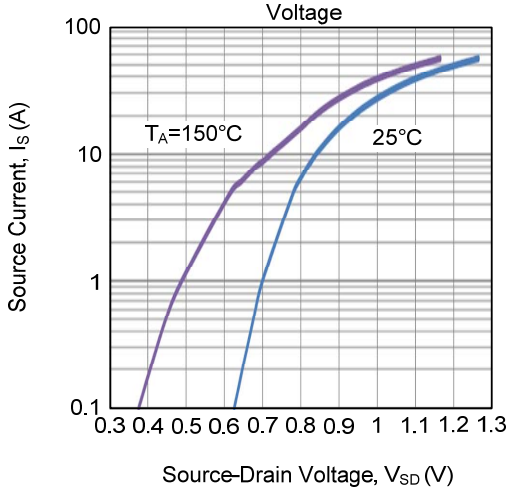


■ TYPICAL CHARACTERISTICS (Cont.)

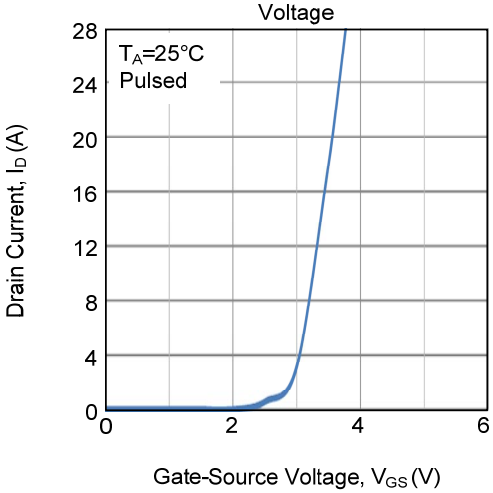
Gate Threshold Voltage vs. Junction Temperature



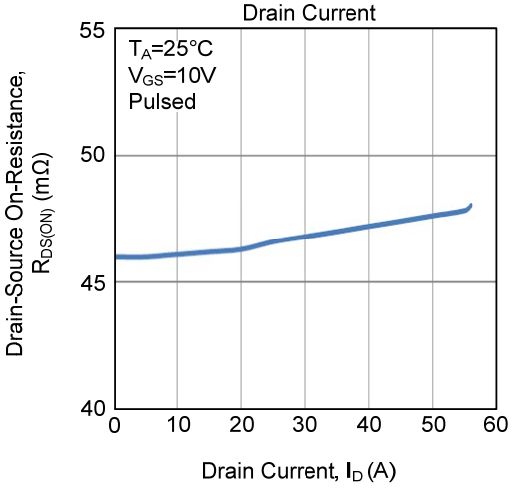
Source Current vs. Source-Drain Voltage



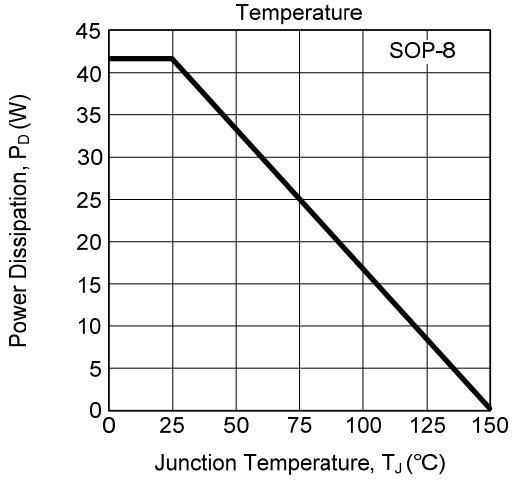
Drain Current vs. Gate-Source Voltage



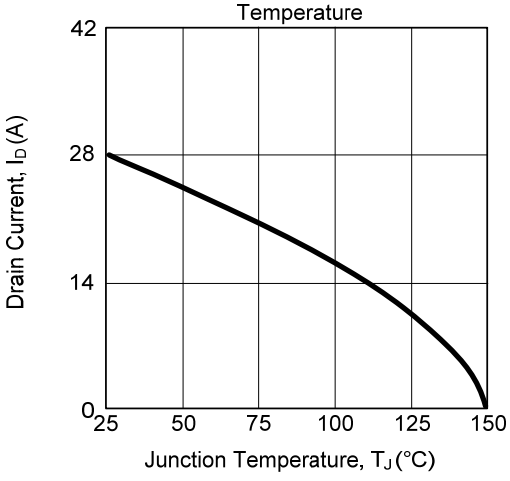
Drain-Source On-Resistance vs. Drain Current



Power Dissipation vs. Junction Temperature



Drain Current vs. Junction Temperature



■ TYPICAL CHARACTERISTICS (Cont.)